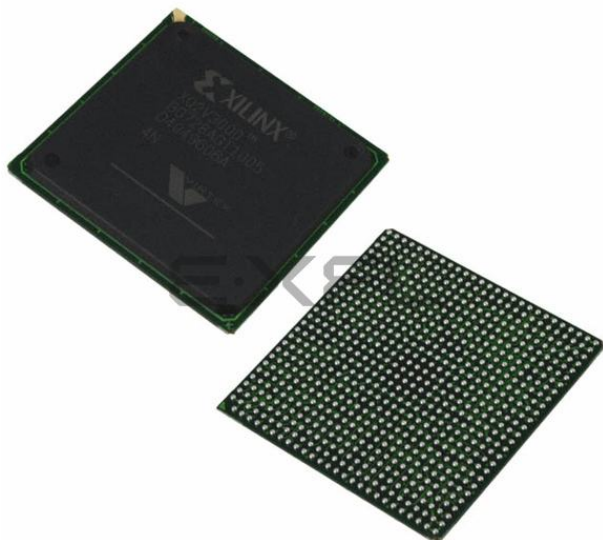




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

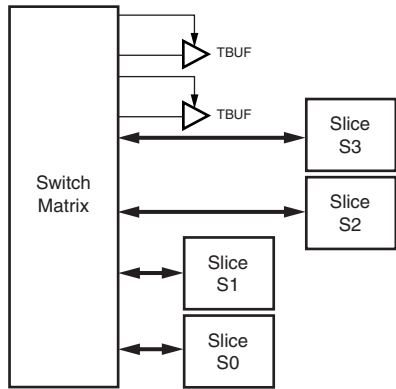
Product Status	Obsolete
Number of LABs/CLBs	3584
Number of Logic Elements/Cells	-
Total RAM Bits	1769472
Number of I/O	516
Number of Gates	3000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	728-BBGA
Supplier Device Package	728-MBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v3000-5bg728i

3-State Buffers

Introduction

Each Virtex-II CLB contains two 3-state drivers (TBUFs) that can drive on-chip busses. Each 3-state buffer has its own 3-state control pin and its own input pin.

Each of the four slices have access to the two 3-state buffers through the switch matrix, as shown in Figure 27. TBUFs in neighboring CLBs can access slice outputs by direct connects. The outputs of the 3-state buffers drive horizontal routing resources used to implement 3-state busses.



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Figure 27: Virtex-II 3-State Buffers

The 3-state buffer logic is implemented using AND-OR logic rather than 3-state drivers, so that timing is more predictable and less load dependant especially with larger devices.

Locations / Organization

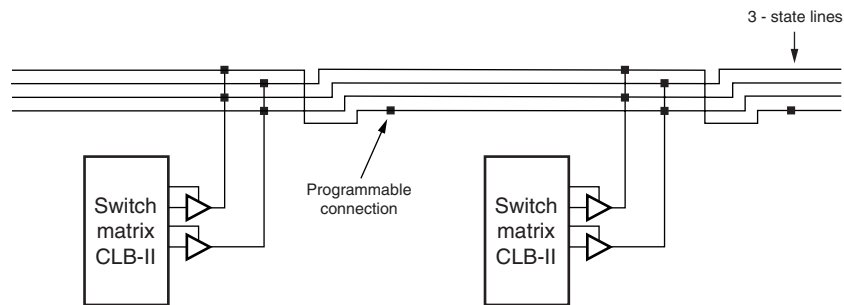
Four horizontal routing resources per CLB are provided for on-chip 3-state busses. Each 3-state buffer has access alternately to two horizontal lines, which can be partitioned as shown in Figure 28. The switch matrices corresponding to SelectRAM memory and multiplier or I/O blocks are skipped.

Number of 3-State Buffers

Table 11 shows the number of 3-state buffers available in each Virtex-II device. The number of 3-state buffers is twice the number of CLB elements.

Table 11: Virtex-II 3-State Buffers

Device	3-State Buffers per Row	Total Number of 3-State Buffers
XC2V40	16	128
XC2V80	16	256
XC2V250	32	768
XC2V500	48	1,536
XC2V1000	64	2,560
XC2V1500	80	3,840
XC2V2000	96	5,376
XC2V3000	112	7,168
XC2V4000	144	11,520
XC2V6000	176	16,896
XC2V8000	208	23,296



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Figure 28: 3-State Buffer Connection to Horizontal Lines

CLB/Slice Configurations

Table 12 summarizes the logic resources in one CLB. All of the CLBs are identical and each CLB or slice can be implemented in one of the configurations listed. Table 13 shows the available resources in all CLBs.

Table 12: Logic Resources in One CLB

Slices	LUTs	Flip-Flops	MULT_ANDs	Arithmetic & Carry-Chains	SOP Chains	Distributed SelectRAM	Shift Registers	TBUF
4	8	8	8	2	2	128 bits	128 bits	2

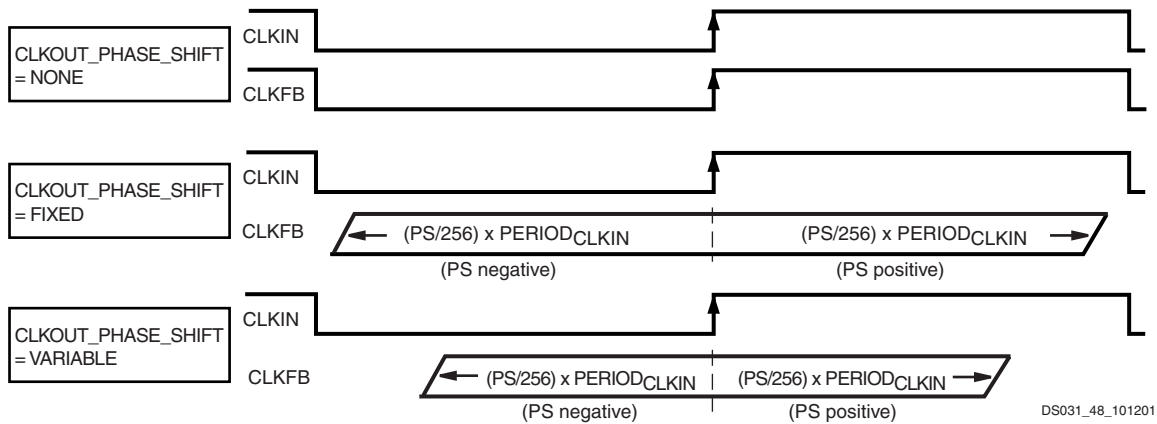


Figure 46: Fine-Phase Shifting Effects

Table 22 lists fine-phase shifting control pins, when used in variable mode.

Table 22: Fine-Phase Shifting Control Pins

Control Pin	Direction	Function
PSINCDEC	in	Increment or decrement
PSEN	in	Enable $\pm$ phase shift
PSCLK	in	Clock for phase shift
PSDONE	out	Active when completed

Two separate components of the phase shift range must be understood:

- PHASE_SHIFT attribute range
- FINE_SHIFT_RANGE DCM timing parameter range

The PHASE_SHIFT attribute is the numerator in the following equation:

$$\text{Phase Shift (ns)} = (\text{PHASE_SHIFT}/256) * \text{PERIOD}_{\text{CLKIN}}$$

The full range of this attribute is always -255 to +255, but its practical range varies with CLKIN frequency, as constrained by the FINE_SHIFT_RANGE component, which represents the total delay achievable by the phase shift delay line. Total delay is a function of the number of delay taps used in the circuit. Across process, voltage, and temperature, this absolute range is guaranteed to be as specified under **DCM Timing Parameters** in Module 3.

Absolute range (fixed mode) = $\pm$ FINE_SHIFT_RANGE

Absolute range (variable mode) = $\pm$ FINE_SHIFT_RANGE/2

Table 23: DCM Frequency Ranges

Output Clock	Low-Frequency Mode		High-Frequency Mode	
	CLKIN Input	CLK Output	CLKIN Input	CLK Output
CLK0, CLK180	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_1X_LF	CLKIN_FREQ_DLL_HF	CLKOUT_FREQ_1X_HF
CLK90, CLK270	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_1X_LF	NA	NA
CLK2X, CLK2X180	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_2X_LF	NA	NA
CLKDV	CLKIN_FREQ_DLL_LF	CLKOUT_FREQ_DV_LF	CLKIN_FREQ_DLL_HF	CLKOUT_FREQ_DV_HF
CLKFX, CLKFX180	CLKIN_FREQ_FX_LF	CLKOUT_FREQ_FX_LF	CLKIN_FREQ_FX_HF	CLKOUT_FREQ_FX_HF

The reason for the difference between fixed and variable modes is as follows. For variable mode to allow symmetric, dynamic sweeps from -255/256 to +255/256, the DCM sets the "zero phase skew" point as the middle of the delay line, thus dividing the total delay line range in half. In fixed mode, since the PHASE_SHIFT value never changes after configuration, the entire delay line is available for insertion into either the CLKIN or CLKFB path (to create either positive or negative skew).

Taking both of these components into consideration, the following are some usage examples:

- If $\text{PERIOD}_{\text{CLKIN}} = 2 * \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT in fixed mode is limited to ± 128 , and in variable mode it is limited to ± 64 .
- If $\text{PERIOD}_{\text{CLKIN}} = \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT in fixed mode is limited to ± 255 , and in variable mode it is limited to ± 128 .
- If $\text{PERIOD}_{\text{CLKIN}} \leq 0.5 * \text{FINE_SHIFT_RANGE}$, then PHASE_SHIFT is limited to ± 255 in either mode.

Operating Modes

The frequency ranges of DCM input and output clocks depend on the operating mode specified, either low-frequency mode or high-frequency mode, according to **Table 23**. (For actual values, see **Virtex-II Switching Characteristics** in Module 3). The CLK2X, CLK2X180, CLK90, and CLK270 outputs are not available in high-frequency mode.

High or low-frequency mode is selected by an attribute.

Virtex-II FPGA device. Timing is similar to the Slave Serial-MAP mode except that CCLK is supplied by the Virtex-II FPGA.

Boundary-Scan (JTAG, IEEE 1532) Mode

In Boundary-Scan mode, dedicated pins are used for configuring the Virtex-II device. The configuration is done entirely through the IEEE 1149.1 Test Access Port (TAP). Virtex-II device configuration using Boundary-Scan is compatible with the IEEE 1149.1-1993 standard and the new

IEEE 1532 standard for In-System Configurable (ISC) devices. The IEEE 1532 standard is backward compliant with the IEEE 1149.1-1993 TAP and state machine. The IEEE Standard 1532 for In-System Configurable (ISC) devices is intended to be programmed, reprogrammed, or tested on the board via a physical and logical protocol.

Configuration through the Boundary-Scan port is always available, independent of the mode selection. Selecting the Boundary-Scan mode simply turns off the other modes.

Table 25: Virtex-II Configuration Mode Pin Settings

Configuration Mode ⁽¹⁾	M2	M1	M0	CCLK Direction	Data Width	Serial D _{OUT} ⁽²⁾
Master Serial	0	0	0	Out	1	Yes
Slave Serial	1	1	1	In	1	Yes
Master SelectMAP	0	1	1	Out	8	No
Slave SelectMAP	1	1	0	In	8	No
Boundary-Scan	1	0	1	N/A	1	No

Notes:

1. The HSWAP_EN pin controls the pull-ups. Setting M2, M1, and M0 selects the configuration mode, while the HSWAP_EN pin controls whether or not the pull-ups are used.
2. Daisy chaining is possible only in modes where Serial D_{OUT} is used. For example, in SelectMAP modes, the first device does NOT support daisy chaining of downstream devices.

Table 26 lists the total number of bits required to configure each device.

Table 26: Virtex-II Bitstream Lengths

Device	# of Configuration Bits
XC2V40	338,976
XC2V80	598,816
XC2V250	1,593,632
XC2V500	2,560,544
XC2V1000	4,082,592
XC2V1500	5,170,208
XC2V2000	6,812,960
XC2V3000	10,494,368
XC2V4000	15,659,936
XC2V6000	21,849,504
XC2V8000	26,194,208

Configuration Sequence

The configuration of Virtex-II devices is a three-phase process after Power On Reset or POR. POR occurs when V_{CCINT} is greater than 1.2V, V_{CCAUX} is greater than 2.5V,

and V_{CCO} (bank 4) is greater than 1.5V. Once the POR voltages have been reached, the three-phase process begins.

First, the configuration memory is cleared. Next, configuration data is loaded into the memory, and finally, the logic is activated by a start-up process.

Configuration is automatically initiated on power-up unless it is delayed by the user. The INIT_B pin can be held Low using an open-drain driver. An open-drain is required since INIT_B is a bidirectional open-drain pin that is held Low by a Virtex-II FPGA device while the configuration memory is being cleared. Extending the time that the pin is Low causes the configuration sequencer to wait. Thus, configuration is delayed by preventing entry into the phase where data is loaded.

The configuration process can also be initiated by asserting the PROG_B pin. The end of the memory-clearing phase is signaled by the INIT_B pin going High, and the completion of the entire process is signaled by the DONE pin going High. The Global Set/Reset (GSR) signal is pulsed after the last frame of configuration data is written but before the start-up sequence. The GSR signal resets all flip-flops on the device.

The default start-up sequence is that one CCLK cycle after DONE goes High, the global 3-state signal (GTS) is released. This permits device outputs to turn on as necessary. One CCLK cycle later, the Global Write Enable (GWE) signal is released. This permits the internal storage ele-

Enhanced Multiplier Switching Characteristics

Table 26 and Table 27 provide timing information for enhanced Virtex-II multiplier blocks, available in stepping revisions of Virtex-II devices. For more information on stepping revisions, availability, and ordering instructions, see your local sales representative.

Table 26: Enhanced Multiplier Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Propagation Delay to Output Pin					
Input to Pin 35	T _{MULT1_P35}	4.66	5.14	5.91	ns, Max
Input to Pin 34	T _{MULT1_P34}	4.57	5.03	5.79	ns, Max
Input to Pin 33	T _{MULT1_P33}	4.47	4.93	5.66	ns, Max
Input to Pin 32	T _{MULT1_P32}	4.37	4.82	5.54	ns, Max
Input to Pin 31	T _{MULT1_P31}	4.28	4.71	5.42	ns, Max
Input to Pin 30	T _{MULT1_P30}	4.18	4.61	5.29	ns, Max
Input to Pin 29	T _{MULT1_P29}	4.08	4.50	5.17	ns, Max
Input to Pin 28	T _{MULT1_P28}	3.99	4.39	5.05	ns, Max
Input to Pin 27	T _{MULT1_P27}	3.89	4.28	4.92	ns, Max
Input to Pin 26	T _{MULT1_P26}	3.79	4.18	4.80	ns, Max
Input to Pin 25	T _{MULT1_P25}	3.69	4.07	4.68	ns, Max
Input to Pin 24	T _{MULT1_P24}	3.60	3.96	4.56	ns, Max
Input to Pin 23	T _{MULT1_P23}	3.50	3.86	4.43	ns, Max
Input to Pin 22	T _{MULT1_P22}	3.40	3.75	4.31	ns, Max
Input to Pin 21	T _{MULT1_P21}	3.31	3.64	4.19	ns, Max
Input to Pin 20	T _{MULT1_P20}	3.21	3.54	4.06	ns, Max
Input to Pin 19	T _{MULT1_P19}	3.11	3.43	3.94	ns, Max
Input to Pin 18	T _{MULT1_P18}	3.02	3.32	3.82	ns, Max
Input to Pin 17	T _{MULT1_P17}	2.92	3.21	3.69	ns, Max
Input to Pin 16	T _{MULT1_P16}	2.82	3.11	3.57	ns, Max
Input to Pin 15	T _{MULT1_P15}	2.72	3.00	3.45	ns, Max
Input to Pin 14	T _{MULT1_P14}	2.63	2.89	3.33	ns, Max
Input to Pin 13	T _{MULT1_P13}	2.53	2.79	3.20	ns, Max
Input to Pin 12	T _{MULT1_P12}	2.43	2.68	3.08	ns, Max
Input to Pin 11	T _{MULT1_P11}	2.34	2.57	2.96	ns, Max
Input to Pin 10	T _{MULT1_P10}	2.24	2.47	2.83	ns, Max
Input to Pin 9	T _{MULT1_P9}	2.14	2.36	2.71	ns, Max
Input to Pin 8	T _{MULT1_P8}	2.05	2.25	2.59	ns, Max
Input to Pin 7	T _{MULT1_P7}	1.95	2.14	2.46	ns, Max
Input to Pin 6	T _{MULT1_P6}	1.85	2.04	2.34	ns, Max
Input to Pin 5	T _{MULT1_P5}	1.75	1.93	2.22	ns, Max
Input to Pin 4	T _{MULT1_P4}	1.66	1.82	2.10	ns, Max
Input to Pin 3	T _{MULT1_P3}	1.56	1.72	1.97	ns, Max
Input to Pin 2	T _{MULT1_P2}	1.46	1.61	1.85	ns, Max
Input to Pin 1	T _{MULT1_P1}	1.37	1.50	1.73	ns, Max
Input to Pin 0	T _{MULT1_P0}	1.27	1.40	1.60	ns, Max

Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

Table 4: Virtex-II Pin Definitions

Pin Name	Direction	Description
User I/O Pins		
IO_LXXY_#	Input/Output/ Bidirectional	All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled “IO_LXXY_#”, where: IO indicates a user I/O pin. LXXY indicates a differential pair, with XX a unique pair in the bank and Y = P/N for the positive and negative sides of the differential pair. # indicates the bank number (0 through 7)
Dual-Function Pins		
IO_LXXY_#/ZZZ		The dual-function pins are labelled “IO_LXXY_#/ZZZ”, where ZZZ can be one of the following pins: Per Bank - VRP , VRN , or VREF Globally - GCLKX(S/P) , BUSY/DOUT , INIT_B , D0/DIN – D7 , RDWR_B , or CS_B
With /ZZZ:		
D0/DIN, D1, D2, D3, D4, D5, D6, D7	Input/Output	<i>In SelectMAP mode</i>, D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained. <i>In bit-serial modes</i>, DIN (D0) is the single-data input. This pin becomes a user I/O after configuration.
CS_B	Input	In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
RDWR_B	Input	In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
BUSY/DOUT	Output	<i>In SelectMAP mode</i>, BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. <i>In bit-serial modes</i>, DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration.
INIT_B	Bidirectional (open-drain)	When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration.
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
ALT_VRP	Input	This is the alternative pin for the DCI voltage reference resistor of P transistor.
ALT_VRN	Input	This is the alternative pin for the DCI voltage reference resistor of N transistor.
V _{REF}	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
Dedicated Pins⁽¹⁾		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
3	IO_L52P_3	P18	NC	
3	IO_L51N_3/VREF_3	P22	NC	
3	IO_L51P_3	P21	NC	
3	IO_L49N_3	P20	NC	
3	IO_L49P_3	P19	NC	
3	IO_L48N_3	R22		
3	IO_L48P_3	R21		
3	IO_L46N_3	R20		
3	IO_L46P_3	R19		
3	IO_L45N_3/VREF_3	R18		
3	IO_L45P_3	P17		
3	IO_L43N_3	T22		
3	IO_L43P_3	T21		
3	IO_L24N_3	T20	NC	NC
3	IO_L24P_3	T19	NC	NC
3	IO_L22N_3	U22	NC	NC
3	IO_L22P_3	U21	NC	NC
3	IO_L21N_3/VREF_3	U20	NC	NC
3	IO_L21P_3	U19	NC	NC
3	IO_L19N_3	T18	NC	NC
3	IO_L19P_3	U18	NC	NC
3	IO_L06N_3	V22		
3	IO_L06P_3	V21		
3	IO_L04N_3	V20		
3	IO_L04P_3	V19		
3	IO_L03N_3/VREF_3	W22		
3	IO_L03P_3	W21		
3	IO_L02N_3/VRP_3	Y22		
3	IO_L02P_3/VRN_3	Y21		
3	IO_L01N_3	W20		
3	IO_L01P_3	AA20		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AB19		
4	IO_L01P_4/INIT_B	AA19		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
7	IO_L51N_7	J2	NC	
7	IO_L49P_7	J3	NC	
7	IO_L49N_7	J4	NC	
7	IO_L48P_7	H1		
7	IO_L48N_7	H2		
7	IO_L46P_7	H3		
7	IO_L46N_7	H4		
7	IO_L45P_7/VREF_7	J6		
7	IO_L45N_7	H5		
7	IO_L43P_7	G1		
7	IO_L43N_7	G2		
7	IO_L24P_7	G3	NC	NC
7	IO_L24N_7	G4	NC	NC
7	IO_L22P_7	F1	NC	NC
7	IO_L22N_7	F2	NC	NC
7	IO_L21P_7/VREF_7	F3	NC	NC
7	IO_L21N_7	F4	NC	NC
7	IO_L19P_7	G5	NC	NC
7	IO_L19N_7	F5	NC	NC
7	IO_L06P_7	E1		
7	IO_L06N_7	E2		
7	IO_L04P_7	E3		
7	IO_L04N_7	E4		
7	IO_L03P_7/VREF_7	D1		
7	IO_L03N_7	D2		
7	IO_L02P_7/VRN_7	C1		
7	IO_L02N_7/VRP_7	C2		
7	IO_L01P_7	E5		
7	IO_L01N_7	E6		
0	VCCO_0	G11		
0	VCCO_0	G10		
0	VCCO_0	G9		
0	VCCO_0	F8		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
0	VCCO_0	F7		
1	VCCO_1	G14		
1	VCCO_1	G13		
1	VCCO_1	G12		
1	VCCO_1	F16		
1	VCCO_1	F15		
2	VCCO_2	L16		
2	VCCO_2	K16		
2	VCCO_2	J16		
2	VCCO_2	H17		
2	VCCO_2	G17		
3	VCCO_3	T17		
3	VCCO_3	R17		
3	VCCO_3	P16		
3	VCCO_3	N16		
3	VCCO_3	M16		
4	VCCO_4	U16		
4	VCCO_4	U15		
4	VCCO_4	T14		
4	VCCO_4	T13		
4	VCCO_4	T12		
5	VCCO_5	U8		
5	VCCO_5	U7		
5	VCCO_5	T11		
5	VCCO_5	T10		
5	VCCO_5	T9		
6	VCCO_6	T6		
6	VCCO_6	R6		
6	VCCO_6	P7		
6	VCCO_6	N7		
6	VCCO_6	M7		
7	VCCO_7	L7		
7	VCCO_7	K7		
7	VCCO_7	J7		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L78N_4	Y15	NC	
4	IO_L78P_4	AA15	NC	
4	IO_L91N_4/VREF_4	W15		
4	IO_L91P_4	W16		
4	IO_L92N_4	AB15		
4	IO_L92P_4	AC15		
4	IO_L93N_4	AD15		
4	IO_L93P_4	AE15		
4	IO_L94N_4/VREF_4	W14		
4	IO_L94P_4	Y14		
4	IO_L95N_4/GCLK3S	AA14		
4	IO_L95P_4/GCLK2P	AB14		
4	IO_L96N_4/GCLK1S	AC14		
4	IO_L96P_4/GCLK0P	AD14		
5	IO_L96N_5/GCLK7S	AC13		
5	IO_L96P_5/GCLK6P	AB13		
5	IO_L95N_5/GCLK5S	AA13		
5	IO_L95P_5/GCLK4P	Y13		
5	IO_L94N_5	W13		
5	IO_L94P_5/VREF_5	W12		
5	IO_L93N_5	AF15		
5	IO_L93P_5	AF14		
5	IO_L92N_5	AF13		
5	IO_L92P_5	AF12		
5	IO_L91N_5	AE12		
5	IO_L91P_5/VREF_5	AD12		
5	IO_L78N_5	AC12	NC	
5	IO_L78P_5	AB12	NC	
5	IO_L76N_5	AA12	NC	
5	IO_L76P_5	Y12	NC	
5	IO_L75N_5/VREF_5	AF11	NC	
5	IO_L75P_5	AF10	NC	
5	IO_L73N_5	AE11	NC	
5	IO_L73P_5	AD11	NC	
5	IO_L72N_5	AC11		
5	IO_L72P_5	AB11		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
6	IO_L52N_6	U1		
6	IO_L54P_6	U7		
6	IO_L54N_6	T7		
6	IO_L67P_6	U4		
6	IO_L67N_6	U3		
6	IO_L69P_6	U6		
6	IO_L69N_6/VREF_6	U5		
6	IO_L70P_6	T5		
6	IO_L70N_6	T6		
6	IO_L72P_6	T8		
6	IO_L72N_6	R8		
6	IO_L73P_6	T2	NC	
6	IO_L73N_6	T1	NC	
6	IO_L75P_6	T4	NC	
6	IO_L75N_6/VREF_6	T3	NC	
6	IO_L76P_6	R6	NC	
6	IO_L76N_6	R5	NC	
6	IO_L78P_6	R4	NC	
6	IO_L78N_6	R3	NC	
6	IO_L91P_6	R2		
6	IO_L91N_6	R1		
6	IO_L93P_6	R7		
6	IO_L93N_6/VREF_6	P7		
6	IO_L94P_6	P6		
6	IO_L94N_6	P5		
6	IO_L96P_6	P4		
6	IO_L96N_6	P3		
7	IO_L96P_7	P1		
7	IO_L96N_7	N1		
7	IO_L94P_7	N4		
7	IO_L94N_7	N5		
7	IO_L93P_7/VREF_7	N6		
7	IO_L93N_7	N7		
7	IO_L91P_7	P8		
7	IO_L91N_7	N8		
7	IO_L78P_7	M1	NC	

BG575/BGG575 Standard BGA Package

As shown in [Table 9](#), XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the **BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch)**.

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
6	IO_L91N_6	P4		
6	IO_L93P_6	N4		
6	IO_L93N_6/VREF_6	N3		
6	IO_L94P_6	N6		
6	IO_L94N_6	N5		
6	IO_L96P_6	N8		
6	IO_L96N_6	N7		
7	IO_L96P_7	N2		
7	IO_L96N_7	M1		
7	IO_L94P_7	M2		
7	IO_L94N_7	M3		
7	IO_L93P_7/VREF_7	M4		
7	IO_L93N_7	M5		
7	IO_L91P_7	M6		
7	IO_L91N_7	M7		
7	IO_L73P_7	M8	NC	NC
7	IO_L73N_7	L8	NC	NC
7	IO_L72P_7	L1	NC	
7	IO_L72N_7	K1	NC	
7	IO_L70P_7	K2	NC	
7	IO_L70N_7	K3	NC	
7	IO_L69P_7/VREF_7	L3	NC	
7	IO_L69N_7	L4	NC	
7	IO_L67P_7	L5	NC	
7	IO_L67N_7	L7	NC	
7	IO_L54P_7	J1		
7	IO_L54N_7	H1		
7	IO_L52P_7	J2		
7	IO_L52N_7	J3		
7	IO_L51P_7/VREF_7	J4		
7	IO_L51N_7	J5		
7	IO_L49P_7	K5		
7	IO_L49N_7	K6		
7	IO_L48P_7	F1		
7	IO_L48N_7	F2		

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
1	IO_L94N_1	C15
1	IO_L94P_1/VREF_1	D15
1	IO_L93N_1	E15
1	IO_L93P_1	F15
1	IO_L92N_1	G15
1	IO_L92P_1	H15
1	IO_L91N_1	J15
1	IO_L91P_1/VREF_1	J16
1	IO_L78N_1	A16
1	IO_L78P_1	B16
1	IO_L76N_1	D16
1	IO_L76P_1	E16
1	IO_L75N_1/VREF_1	F16
1	IO_L75P_1	F17
1	IO_L73N_1	H16
1	IO_L73P_1	H17
1	IO_L72N_1	A17
1	IO_L72P_1	B17
1	IO_L70N_1	C17
1	IO_L70P_1	D17
1	IO_L69N_1/VREF_1	G18
1	IO_L69P_1	G17
1	IO_L67N_1	A18
1	IO_L67P_1	B18
1	IO_L54N_1	C18
1	IO_L54P_1	D18
1	IO_L52N_1	E18
1	IO_L52P_1	F18
1	IO_L51N_1/VREF_1	H19
1	IO_L51P_1	H18
1	IO_L49N_1	A19
1	IO_L49P_1	A20
1	IO_L30N_1	B19
1	IO_L30P_1	C19
1	IO_L28N_1	D19
1	IO_L28P_1	E19

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	VCCAUX	P26
NA	VCCAUX	P2
NA	VCCAUX	C26
NA	VCCAUX	C2
NA	VCCAUX	B14
NA	VCCINT	V18
NA	VCCINT	V14
NA	VCCINT	V10
NA	VCCINT	U17
NA	VCCINT	U16
NA	VCCINT	U15
NA	VCCINT	U14
NA	VCCINT	U13
NA	VCCINT	U12
NA	VCCINT	U11
NA	VCCINT	T17
NA	VCCINT	T11
NA	VCCINT	R17
NA	VCCINT	R11
NA	VCCINT	P18
NA	VCCINT	P17
NA	VCCINT	P11
NA	VCCINT	P10
NA	VCCINT	N17
NA	VCCINT	N11
NA	VCCINT	M17
NA	VCCINT	M11
NA	VCCINT	L17
NA	VCCINT	L16
NA	VCCINT	L15
NA	VCCINT	L14
NA	VCCINT	L13
NA	VCCINT	L12
NA	VCCINT	L11
NA	VCCINT	K18
NA	VCCINT	K14

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	GND	T12
NA	GND	R16
NA	GND	R15
NA	GND	R14
NA	GND	R13
NA	GND	R12
NA	GND	P27
NA	GND	P24
NA	GND	P19
NA	GND	P16
NA	GND	P15
NA	GND	P14
NA	GND	P13
NA	GND	P12
NA	GND	P9
NA	GND	P4
NA	GND	P1
NA	GND	N16
NA	GND	N15
NA	GND	N14
NA	GND	N13
NA	GND	N12
NA	GND	M16
NA	GND	M15
NA	GND	M14
NA	GND	M13
NA	GND	M12
NA	GND	L23
NA	GND	L5
NA	GND	J14
NA	GND	H26
NA	GND	H20
NA	GND	H8
NA	GND	H2
NA	GND	G21
NA	GND	G7

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	IO_L45N_7	J34	
7	IO_L44P_7	M27	
7	IO_L44N_7	L27	
7	IO_L43P_7	H31	
7	IO_L43N_7	J31	
7	IO_L30P_7	F32	
7	IO_L30N_7	G32	
7	IO_L29P_7	N25	
7	IO_L29N_7	M25	
7	IO_L28P_7	F34	
7	IO_L28N_7	G34	
7	IO_L27P_7/VREF_7	J30	
7	IO_L27N_7	H30	
7	IO_L26P_7	K28	
7	IO_L26N_7	L28	
7	IO_L25P_7	H28	
7	IO_L25N_7	J29	
7	IO_L24P_7	G29	
7	IO_L24N_7	H29	
7	IO_L23P_7	L26	
7	IO_L23N_7	K26	
7	IO_L22P_7	F33	
7	IO_L22N_7	G33	
7	IO_L21P_7/VREF_7	J28	
7	IO_L21N_7	J27	
7	IO_L20P_7	K27	
7	IO_L20N_7	J26	
7	IO_L19P_7	E31	
7	IO_L19N_7	F31	
7	IO_L06P_7	D32	
7	IO_L06N_7	E32	
7	IO_L05P_7	L25	
7	IO_L05N_7	K24	
7	IO_L04P_7	D34	
7	IO_L04N_7	E34	
7	IO_L03P_7/VREF_7	G30	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L01N_5/RDWR_B	AU36		
5	IO_L01P_5/CS_B	AV36		
6	IO_L01P_6	AJ27		
6	IO_L01N_6	AH27		
6	IO_L02P_6/VRN_6	AT38		
6	IO_L02N_6/VRP_6	AR37		
6	IO_L03P_6	AP36		
6	IO_L03N_6/VREF_6	AR36		
6	IO_L04P_6	AJ28		
6	IO_L04N_6	AH29		
6	IO_L05P_6	AT39		
6	IO_L05N_6	AR39		
6	IO_L06P_6	AN34		
6	IO_L06N_6	AP35		
6	IO_L07P_6	AH28	NC	
6	IO_L07N_6	AG28	NC	
6	IO_L08P_6	AR38	NC	
6	IO_L08N_6	AP38	NC	
6	IO_L09P_6	AM34	NC	
6	IO_L09N_6/VREF_6	AM33	NC	
6	IO_L10P_6	AL32	NC	
6	IO_L10N_6	AK32	NC	
6	IO_L11P_6	AP37	NC	
6	IO_L11N_6	AN37	NC	
6	IO_L12P_6	AM35	NC	
6	IO_L12N_6	AN35	NC	
6	IO_L19P_6	AK31		
6	IO_L19N_6	AJ30		
6	IO_L20P_6	AP39		
6	IO_L20N_6	AN39		
6	IO_L21P_6	AK33		
6	IO_L21N_6/VREF_6	AL33		
6	IO_L22P_6	AJ31		
6	IO_L22N_6	AH31		
6	IO_L23P_6	AN38		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	DONE	AP7		
NA	M0	AN32		
NA	M1	AP33		
NA	M2	AT35		
NA	HSWAP_EN	E34		
NA	TCK	G8		
NA	TDI	D35		
NA	TDO	E6		
NA	TMS	F7		
NA	PWRDWN_B	AN8		
NA	DXN	G32		
NA	DXP	F33		
NA	VBATT	D5		
NA	RSVD	H9		
NA	VCCAUX	AV20		
NA	VCCAUX	AT37		
NA	VCCAUX	AT3		
NA	VCCAUX	Y38		
NA	VCCAUX	Y2		
NA	VCCAUX	D37		
NA	VCCAUX	D3		
NA	VCCAUX	B20		
NA	VCCINT	AG27		
NA	VCCINT	AG20		
NA	VCCINT	AG13		
NA	VCCINT	AF26		
NA	VCCINT	AF20		
NA	VCCINT	AF14		
NA	VCCINT	AE25		
NA	VCCINT	AE24		
NA	VCCINT	AE23		
NA	VCCINT	AE22		
NA	VCCINT	AE21		
NA	VCCINT	AE20		
NA	VCCINT	AE19		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L53N_7	K30	
7	IO_L52P_7	L28	
7	IO_L52N_7	J28	
7	IO_L51P_7/VREF_7	M24	
7	IO_L51N_7	L24	
7	IO_L50P_7	L29	
7	IO_L50N_7	K29	
7	IO_L49P_7	M25	
7	IO_L49N_7	L25	
7	IO_L48P_7	L26	
7	IO_L48N_7	J26	
7	IO_L47P_7	J31	
7	IO_L47N_7	H31	
7	IO_L46P_7	J29	
7	IO_L46N_7	H29	
7	IO_L45P_7/VREF_7	M22	
7	IO_L45N_7	L22	
7	IO_L44P_7	J30	
7	IO_L44N_7	G30	
7	IO_L43P_7	K27	
7	IO_L43N_7	J27	
7	IO_L27P_7/VREF_7	L23	NC
7	IO_L27N_7	K23	NC
7	IO_L25P_7	G31	NC
7	IO_L25N_7	F31	NC
7	IO_L24P_7	F30	
7	IO_L24N_7	E30	
7	IO_L23P_7	K25	
7	IO_L23N_7	J25	
7	IO_L22P_7	H28	
7	IO_L22N_7	G28	
7	IO_L21P_7/VREF_7	H27	
7	IO_L21N_7	G27	
7	IO_L20P_7	K24	
7	IO_L20N_7	J24	
7	IO_L19P_7	E31	
7	IO_L19N_7	D31	
7	IO_L06P_7	F28	